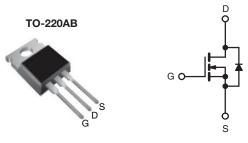




E Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	550			
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.243		
Q _g max. (nC)	66			
Q _{gs} (nC)	8			
Q _{gd} (nC)	14			
Configuration	Single			



N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Low gate charge (Q_a)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Computing
 - PC silver box / ATX power supplies
- Lighting
 - Two stage LED lighting
- Consumer electronics
- Applications using hard switched topologies
 - Power factor correction (PFC)
 - Two switch forward converter
 - Flyback converter
- Switch mode power supplies (SMPS)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and Halogen-free	SiHP15N50E-GE3

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \degree C$, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	500	v	
Gate-Source Voltage			V _{GS}	± 30	v	
Continuous Drain Current (T 150 °C)	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C	Ι _D	14.5		
Continuous Drain Current ($T_J = 150 \ ^{\circ}C$)	V _{GS} at 10 V	T _C = 100 °C		9.2	А	
Pulsed Drain Current ^a			I _{DM}	28		
Linear Derating Factor				1.25	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	136	mJ	
Maximum Power Dissipation			PD	156	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope $V_{DS} = 0 V \text{ to } 80 \% V_{DS}$		dV/dt	70	1//20		
Reverse Diode dV/dt ^d			27	V/ns		
Soldering Recommendations (Peak Temperature) c for 10 s				300	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 3.1 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dI/dt = 100 A/µs, starting T_J = 25 °C.

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.8	0/10	

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Document Number: 91629



1



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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		•			•	•	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μA	500	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.62	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	2.0	-	4.0	V
Octo Course Lookana			V _{GS} = ± 20 V	-	-	± 100	nA
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 30 V	-	-	± 1	μA
Zara Cata Valtaga Drain Current		V _{DS} =	= 500 V, V _{GS} = 0 V	-	-	10	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 400 \	/, V _{GS} = 0 V, T _J = 125 °C	-	-	25	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 7.5 A	-	0.243	0.280	Ω
Forward Transconductance	g fs	V _{DS}	= 30 V, I _D = 7.5 A	-	3.9	-	S
Dynamic		•			•	•	
Input Capacitance	C _{iss}		V _{GS} = 0 V,	-	1162	-	
Output Capacitance	C _{oss}		$V_{DS} = 100 V,$	-	51	-	
Reverse Transfer Capacitance	C _{rss}		f = 1 MHz		7	-	1
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	$V_{DS} = 0 V$ to 400 V, $V_{GS} = 0 V$		-	55	-	pF
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	164	-]
Total Gate Charge	Qq			-	33	66	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	I _D = 7.5 A, V _{DS} = 400 V	-	8	-	nC
Gate-Drain Charge	Q _{gd}				14	-	1
Turn-On Delay Time	t _{d(on)}			-	15	30	
Rise Time	t _r	V _{DD} = 400 V, I _D = 12 A,		-	24	48	- ns
Turn-Off Delay Time	t _{d(off)}		$V_{DD} = 400 \text{ V}, \text{ I}_D = 12 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_g = 9.1 \Omega$		34	68	
Fall Time	t _f		5	-	18	36	1
Gate Input Resistance	Rg	f = 1 MHz, open drain		-	0.85	-	Ω
Drain-Source Body Diode Characteristic	s	•			•	•	
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	14.5	
Pulsed Diode Forward Current	I _{SM}			-	-	28	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 7.5 A, V _{GS} = 0 V		-	-	1.2	V
Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = I _S = 7.5 A,		-	265	-	ns
Reverse Recovery Charge	Q _{rr}			-	3.2	-	μC
Reverse Recovery Current	I _{RRM}		dl/dt = 100 A/µs, V _R = 25 V		23	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

2



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

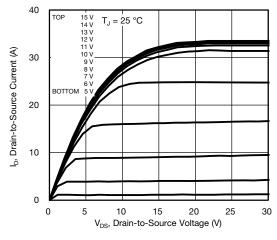


Fig. 1 - Typical Output Characteristics

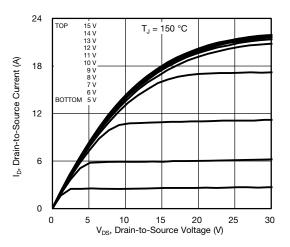


Fig. 2 - Typical Output Characteristics

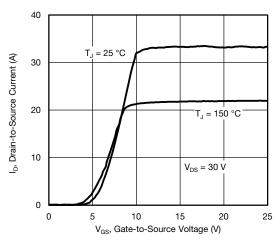


Fig. 3 - Typical Transfer Characteristics

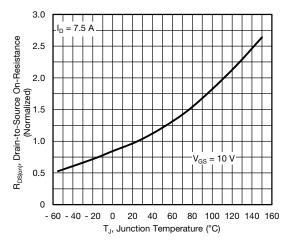


Fig. 4 - Normalized On-Resistance vs. Temperature

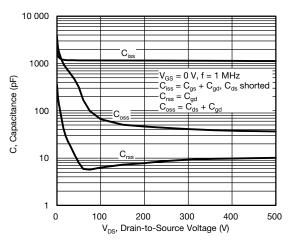


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

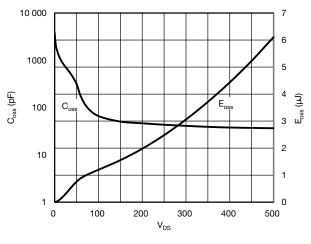


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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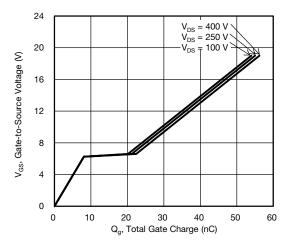


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

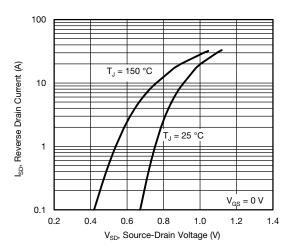
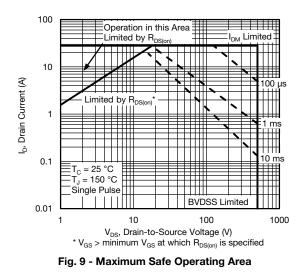


Fig. 8 - Typical Source-Drain Diode Forward Voltage



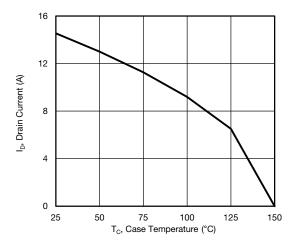


Fig. 10 - Maximum Drain Current vs. Case Temperature

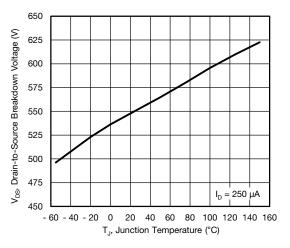


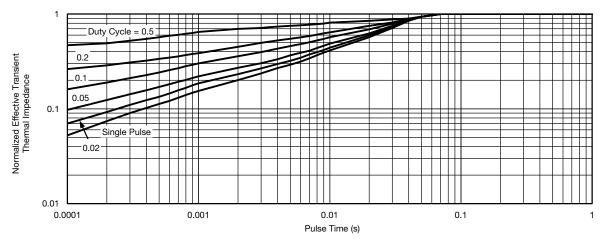
Fig. 11 - Temperature vs. Drain-to-Source Voltage

4

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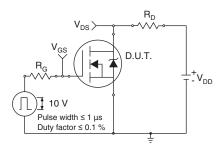


Fig. 13 - Switching Time Test Circuit

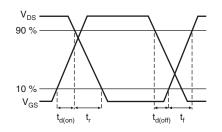


Fig. 14 - Switching Time Waveforms

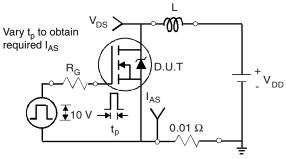


Fig. 15 - Unclamped Inductive Test Circuit

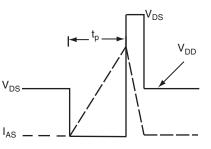


Fig. 16 - Unclamped Inductive Waveforms

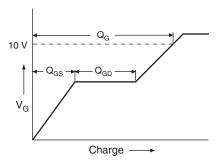


Fig. 17 - Basic Gate Charge Waveform

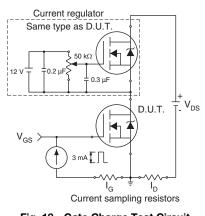


Fig. 18 - Gate Charge Test Circuit

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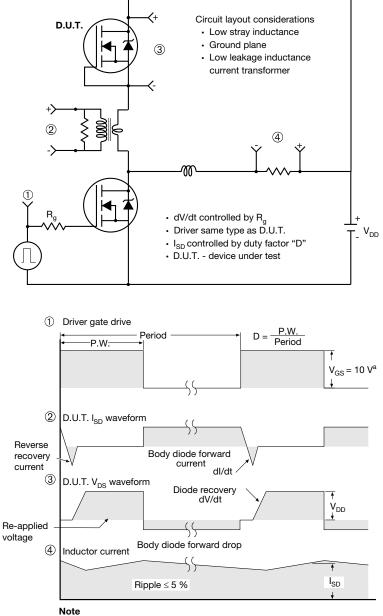
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 19 - For N-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIN.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture					
AS	3E	Xi'an			
		IRF 9510 744K AB			

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